PATENT NUMBER and ISSUE DATE

U.S. UTILITY Patent Application

APPL NUM	FILING DATE	CLASS	SUBCLASS	GAU	EXAMINER	\sqcap			
10081491	02/22/2002	438	100_	2812	lloman	Н			
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35 USC 119 cond	litions met	□ ye	es 🖫 no		CPAC 1008-2 US				
Verified and Acknowledged Examiners's initials Verified and Acknowledged Examiners's initials Delivery CPAC 1008-2 US TITLE: Chip scale package with flip chip interconnect									
US.DEPT. OF COMM./PAT.& TM-PTO-436L(Rev. 12-94)									
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NOTICE OF ALLOWANCE MAILED			CLAIMS ALLOWED			
		Assistant Examiner	Total Claims		Print Claim for O.G	
ISSUE FEE			DRAWING			
Amount Due	Date Paid		Sheets Drwg.	Figs.Drwg.	Print Fig.	
		Primary Examiner				
TERMINAL DISCLAMER		PREPARED FOR ISSUE Application Examiner				
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